



MMBZ15VDL, MMBZ27VCL

40W PEAK POWER DUAL SURFACE MOUNT TVS

Features

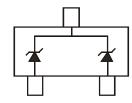
- Dual TVS in Common Cathode Configuration for ESD Protection
- 40 Watt Peak Power Dissipation @1.0ms (Unidirectional)
- 225mW Power Dissipation
- Ideally Suited for Automated Insertion
- Low Leakage
- Lead Free By Design/RoHS Compliant (Note 1)
- Halogen and Antimony Free "Green" Device (Notes 2 & 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Rating Classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)



Top View



Device Schematic

Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
MMBZ15VDL-7-F	Commercial	SOT23	3000/Tape & Reel
MMBZ27VCL-7-F	Commercial	SOT23	3000/Tape & Reel
MMBZ15VDLQ-7	Automotive	SOT23	3000/Tape & Reel
MMBZ27VCLQ-7	Automotive	SOT23	3000/Tape & Reel

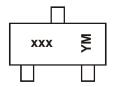
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead.

2. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

3. Product manufactured with Date Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



xxx = Product Type Marking Code: KVJ = MMBZ15VDL KVP = MMBZ27VCL YM = Date Code Marking Y = Year (ex: Z = 2012) M = Month (ex: 9 = September)

Date Code Key

Notes:

Year	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017
Code	Т	U	V	W	Х	Y	Z	А	В	С	D	E
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Power Dissipation (Note 5)	Рек	40	W

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	225	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{\theta JA}$	556	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-65 to +150	С°

Electrical Characteristics @T_A = 25°C unless otherwise specified

$V_F = 0.9V \text{ max}$	@ I _F = 10mA									
				Breakdown Voltage				V _{C @} I _{PP}	(Note 5)	Typical
Type Number	Marking Code	V _{RWM}	I _R @ V _{RWM} (Note 7)	V _{BR} (Note 7) (V)		@ I _T	Vc	IPP	Temperature Coefficient	
		Volts	nA	Min	Nom	Max	mA	V	Α	T _C (%/°C)
MMBZ15VDL	KVJ	12.8	100	14.3	15	15.8	1.0	21.2	1.9	+0.080

V_F = 1.1V max @ I_F = 200mA

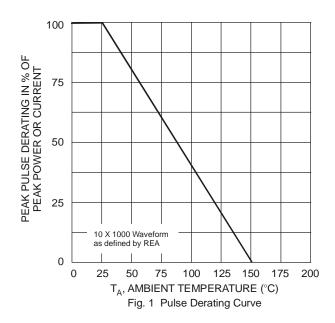
Notes:

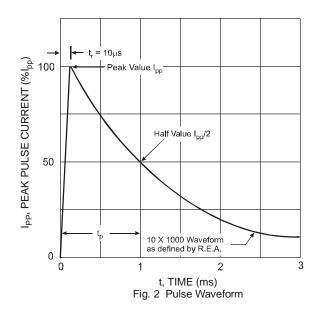
				Breakdown Voltage				Vc @ IPP (Note	5)	Typical
Type Number	Marking Code	V _{RWM}	I _R @ V _{RWM} (Note 7)	V _{BR} (Note 7) (V)			@ IT	Vc	IPP	Temperature Coefficient
		Volts	nA	Min	Nom	Max	mA	V	Α	T _C (%/°C)
MMBZ27VCL	KVP	22	50	25.65	27	28.35	1.0	38	1.0	+0.090

5. Non-repetitive current pulse per Figure 2 and derate above $T_A = 25^{\circ}C$ per Figure 1.

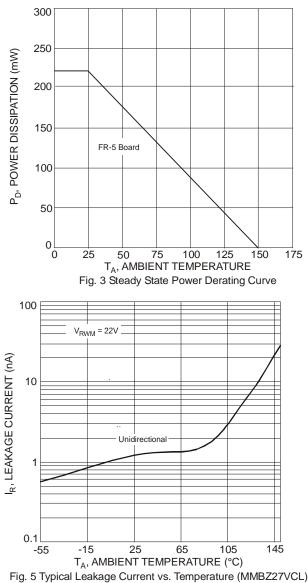
 Device mounted on FR-5 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com. 200mW per element must not be exceeded.

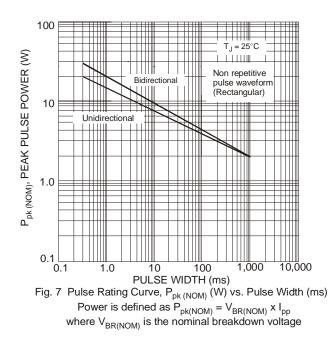
7. Short duration pulse test used to minimize self-heating effect.













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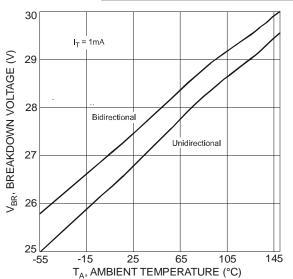
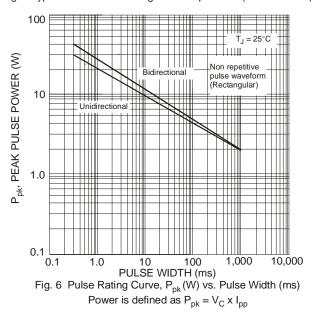


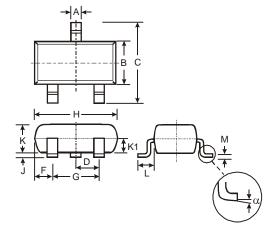
Fig. 4 Typical Breakdown Voltage vs. Temperature (MMBZ27VCL)





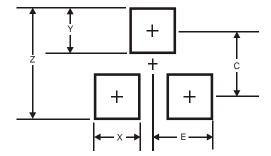
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Package Outline Dimensions



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.30					
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Η	2.80 3.00		2.90				
J	0.013	0.10	0.05				
κ	0.903	1.10	1.00				
K1	-	-	0.400				
L	0.45	0.61	0.55				
Μ	0.085	0.18	0.11				
α	α 0° 8° -						
All	Dimens	ions in	mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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